



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of

Confirmation No. 2949

SASAKI

Allowed: December 19, 2003

Serial No. 09/487,259

Atty Ref.: 1035-243

Filed: January 19, 2000

Group: 2814

For: METHOD FOR MANUFACTURING A  
SEMICONDUCTOR DEVICE BY PARTIALLY  
DICING A SUBSTRATE AND SUBSEQUENT  
CHEMICAL ETCHING

Examiner: A. Mai

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February 25, 2004

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**COMMENTS ON EXAMINER'S  
STATEMENT OF REASONS FOR ALLOWANCE**

Sir:

The Examiner's Statement of Reasons for Allowance refers to a "protective holder having radially-extending grooves ..." The statement should refer to --radially-extending grooves--. Applicant traverses the Examiner's reasons for allowance to the extent these reasons are inconsistent with, add or omit claim limitations.

Respectfully submitted,

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